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**DATA SHEET**

**PART NO. : PC15H120AB**

**REV : A / 0**

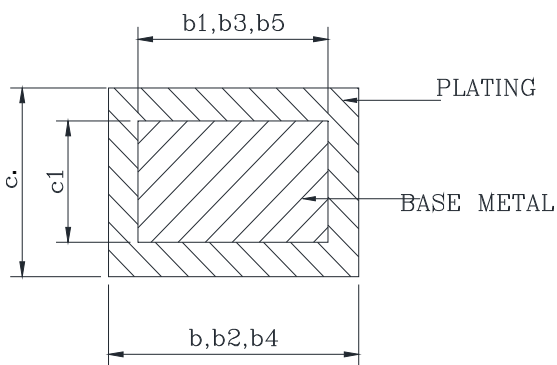
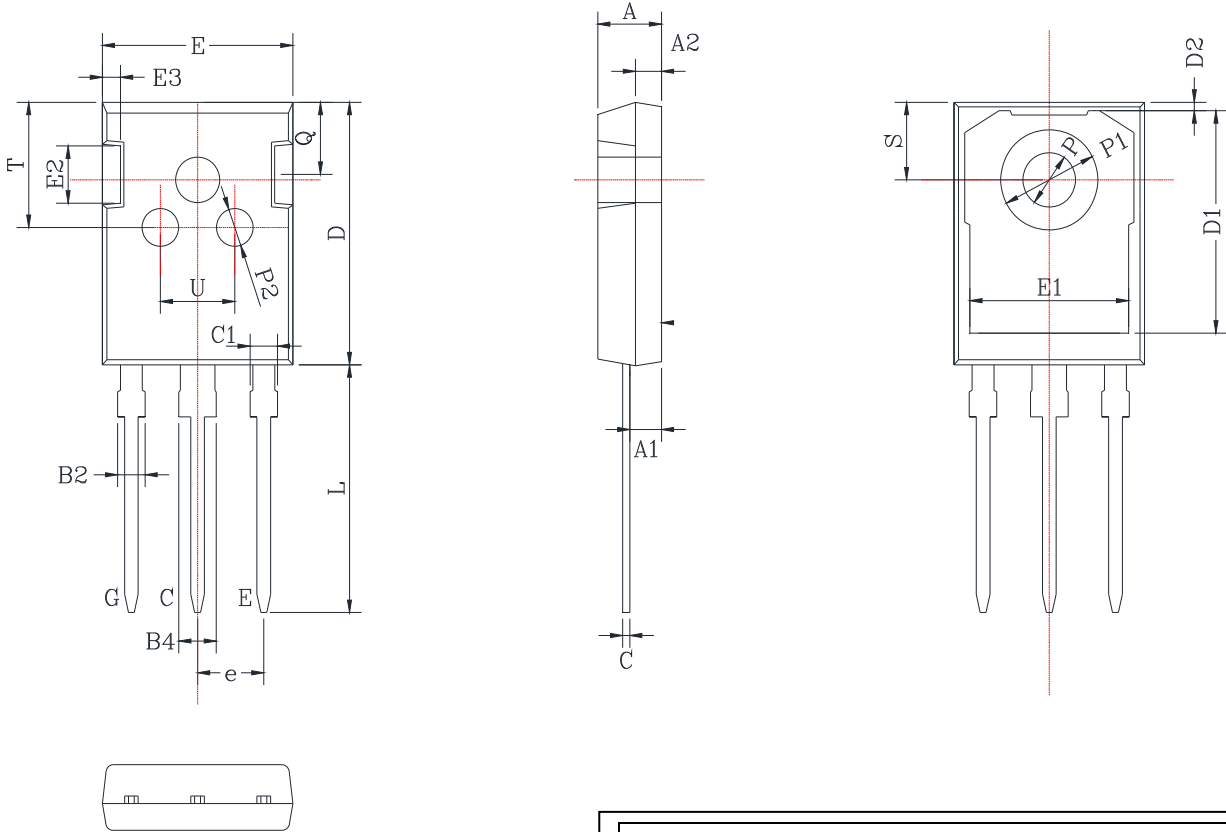
CUSTOMER'S APPROVAL : \_\_\_\_\_ DCC : \_\_\_\_\_

DRAWING NO. : DS-91P-22-0010

DATE : 2023-05-12

Page : 1

### Package Dimensions



SECTION C-C, D-D & E-E

Common dimensions(mm)							
Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
A	4.85	5.0	5.1	P	3.5	3.6	3.7
A1	2.31	2.41	2.51	P1	7.0	-	7.4
A2	1.9	2.0	2.1	P2	2.4	2.5	2.6
B2	-	-	2.2	Q	5.6	-	6.0
B4	-	-	3.2	S	6.05	6.15	6.25
C	0.6	-	0.66	U	6.0	-	6.4
D1	16.25	16.55	16.85	b1	1.15	1.2	1.22
D2	1.05	1.17	1.35	b2	1.96	-	2.06
E	15.7	15.8	15.9	b3	1.95	2.0	2.02
E1	13.06	13.26	13.46	b4	2.96	-	3.06
E2	4.9	5.0	5.1	b5	2.96	3.0	3.02
E3	2.4	2.5	2.6	c	0.59	-	0.66
e	5.41	5.44	5.47	c1	0.58	0.6	0.62
L	19.8	19.92	20.1	D	20.9	21	21.1
T	9.9	10	10.1				

### Features

1200V, 15A

$V_{CE(sat)(typ.)} = 2.2V @ V_{GE} = 15V, I_C = 15A$

Maximum Junction Temperature 150°C

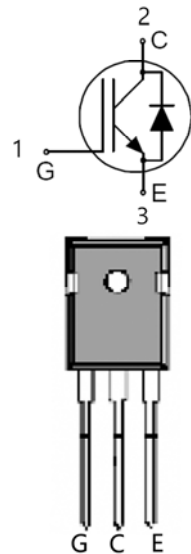
### Applications

IH (induction heating)

UPS

General inverter

Other soft switching applications



### Key Performance and Package Parameters

$V_{CE}$	$I_C$	$V_{CEsat}, T_{vj}=25^{\circ}C$	$T_{vjmax}$
1200V	15A	2.2V	150°C

### Absolute Maximum Ratings

Symbol	Parameter	Value	Units
$V_{CES}$	Collector-Emitter Voltage	1200	V
$V_{GES}$	Gate-Emitter Voltage	$\pm 20$	V
$I_C$	Continuous Collector Current ( $T_C=25^{\circ}C$ )	30	A
	Continuous Collector Current ( $T_C=100^{\circ}C$ )	15	A
$I_{CM}$	Pulsed Collector Current (Note 1)	45	A
$P_D$	Maximum Power Dissipation ( $T_C=25^{\circ}C$ )	180	W
	Maximum Power Dissipation ( $T_C=100^{\circ}C$ )	70	W
$T_J$	Operating Junction Temperature Range	-55 to +150	°C
$T_{STG}$	Storage Temperature Range	-55 to +150	°C

### Thermal Data

Symbol	Parameter	Max.	Units
$R_{\theta JC}$	Thermal Resistance, Junction to case for IGBT	0.68	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction to case for Diode	0.98	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	40	°C/W

### Electrical Characteristics (T<sub>c</sub>=25°C unless otherwise noted.)

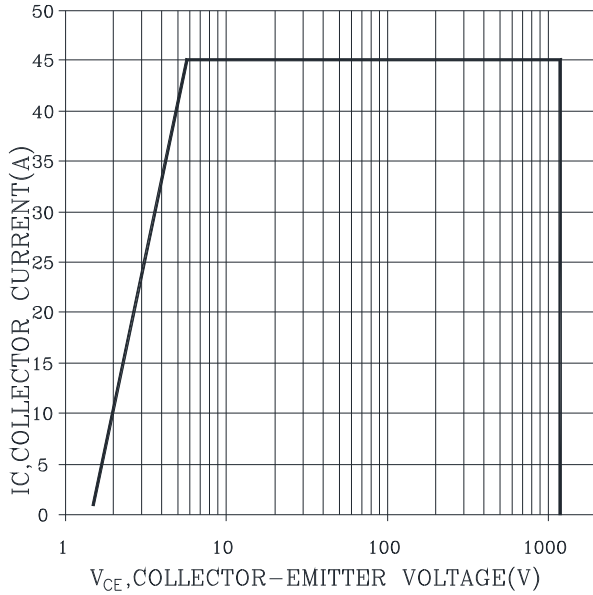
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV <sub>CES</sub>	Collector-Emitter Breakdown Voltage	V <sub>GE</sub> = 0V, I <sub>C</sub> = 250uA	1200	---	---	V
I <sub>CES</sub>	Collector-Emitter Leakage Current	V <sub>CE</sub> = 1200V, V <sub>GE</sub> = 0V	---	---	250	uA
I <sub>GES</sub>	Gate Leakage Current, Forward	V <sub>GE</sub> =30V, V <sub>CE</sub> = 0V	---	---	100	nA
	Gate Leakage Current, Reverse	V <sub>GE</sub> = -30V, V <sub>CE</sub> = 0V	---	---	-100	nA
V <sub>GE(th)</sub>	Gate Threshold Voltage	V <sub>GE</sub> = V <sub>CE</sub> , I <sub>C</sub> = 250uA	4	---	6	V
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	V <sub>GE</sub> =15V, I <sub>C</sub> = 15A	---	2.2	2.7	V
Q <sub>G</sub>	Total Gate Charge	V <sub>CC</sub> =960V	---	70	---	nC
Q <sub>GE</sub>	Gate-Emitter Charge	V <sub>GE</sub> =15V	---	23	---	nC
Q <sub>GC</sub>	Gate-Collector Charge	I <sub>C</sub> =15A	---	24	---	nC
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>CC</sub> =600V V <sub>GE</sub> =15V I <sub>C</sub> =15A R <sub>G</sub> =28Ω Inductive Load T <sub>c</sub> =25°C	---	30	---	ns
t <sub>r</sub>	Turn-on Rise Time		---	35	---	ns
t <sub>d(off)</sub>	Turn-off Delay Time		---	260	---	ns
t <sub>f</sub>	Turn-off Fall Time		---	135	---	ns
E <sub>on</sub>	Turn-on Switching Loss		---	1.3	---	mJ
E <sub>off</sub>	Turn-off Switching Loss		---	0.9	---	mJ
E <sub>ts</sub>	Total Switching Loss		---	2.2	---	mJ
C <sub>ies</sub>	Input Capacitance	V <sub>CE</sub> =25V V <sub>GE</sub> =0V	---	550	---	pF
C <sub>oes</sub>	Output Capacitance	f = 100kHz	---	180	---	pF
C <sub>res</sub>	Reverse Transfer Capacitance		---	110	---	pF
SCSOA	Short Circuit Safe Operation Area		10	---	---	uS

Diode Characteristics ( TC=25°C unless otherwise noted)

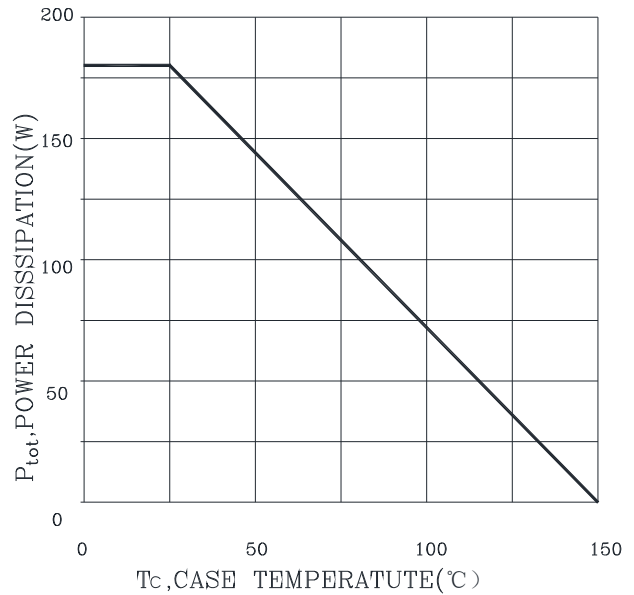
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_F$	Diode Forward Voltage	$I_F=15A$	---	2.3	2.8	V
$t_{rr}$	Diode Reverse Recovery Time	$V_{CE} = 600V$ $I_F= 15A$ $dI_F/dt = 400A/us$	---	240	---	ns
$I_{rr}$	Diode peak Reverse Recovery Current		---	13	---	A
$Q_{rr}$	Diode Reverse Recovery Charge		---	2000	---	nC

Note1: Repetitive rating, pulse width limited by maximum junction temperature

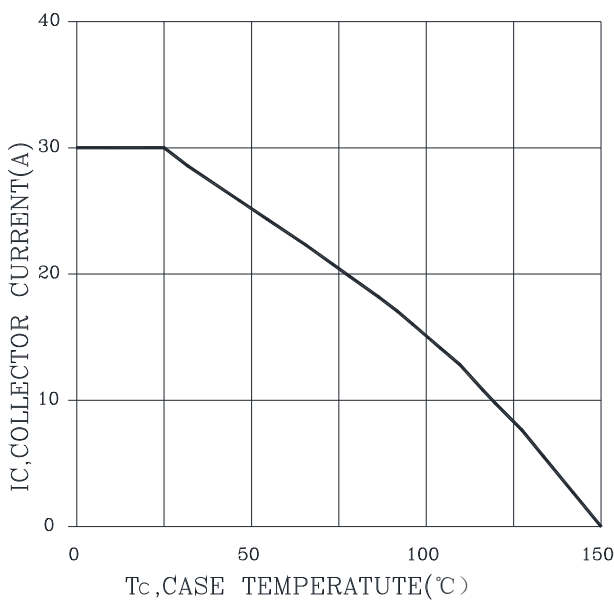
### Typical Performance Characteristics



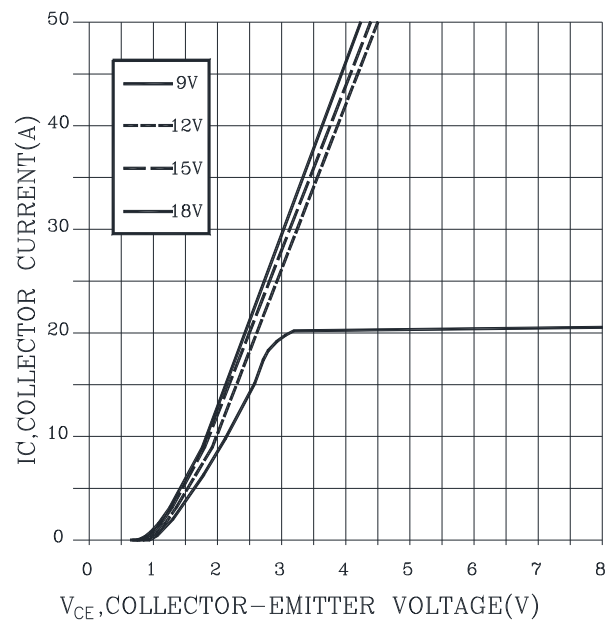
**Fig. 1 Forward bias safe operating area**  
( $T_j \leq 150^\circ\text{C}$ ;  $V_{GE} = 15\text{V}$ )



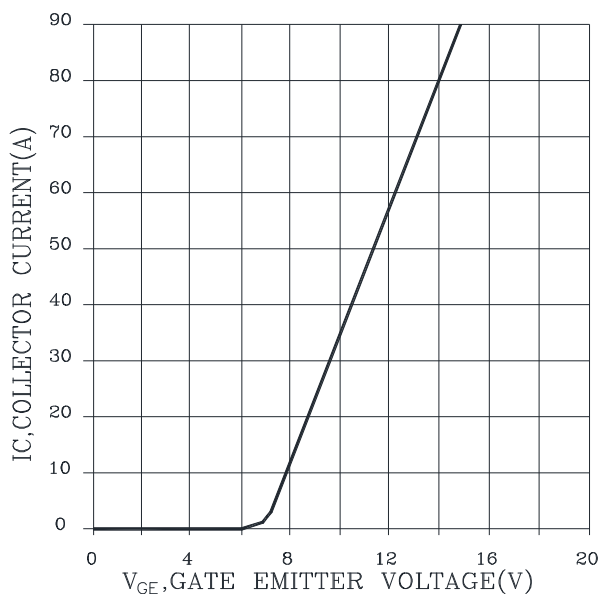
**Fig. 2 Power dissipation as a function of case temperature**



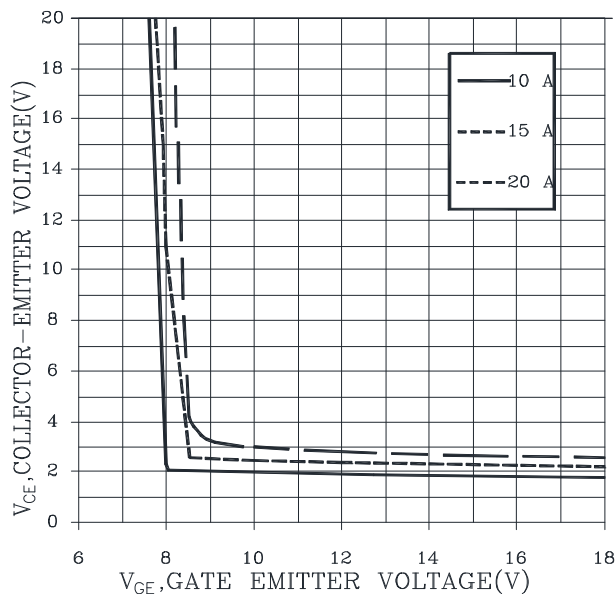
**Fig. 3 Collector current as a function of case temperature**



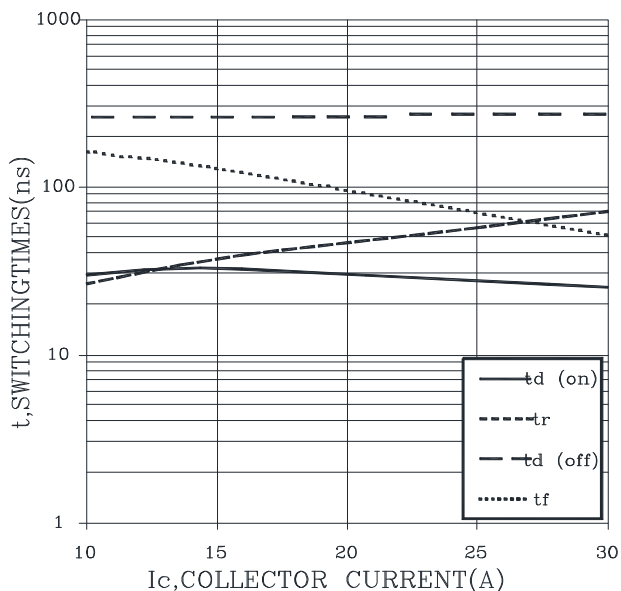
**Fig. 4 Typical output characteristic ( $T_{vj} = 25^\circ\text{C}$ )**



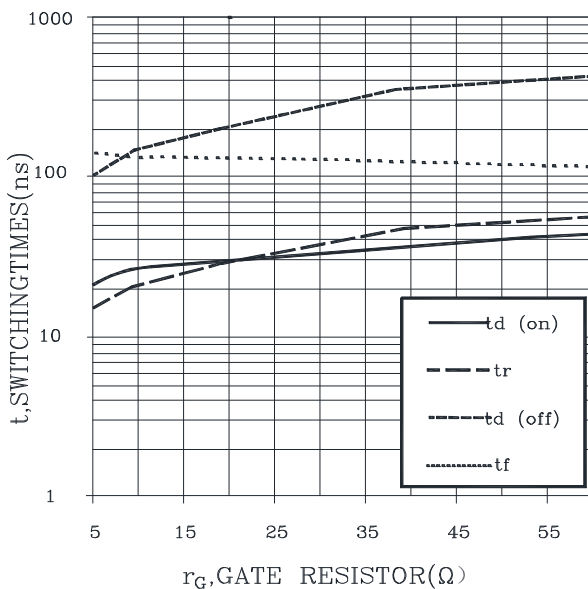
**Fig. 5 Typical transfer characteristics ( $V_{CE}=20V$ ,  $t_p=20\mu s$ )**



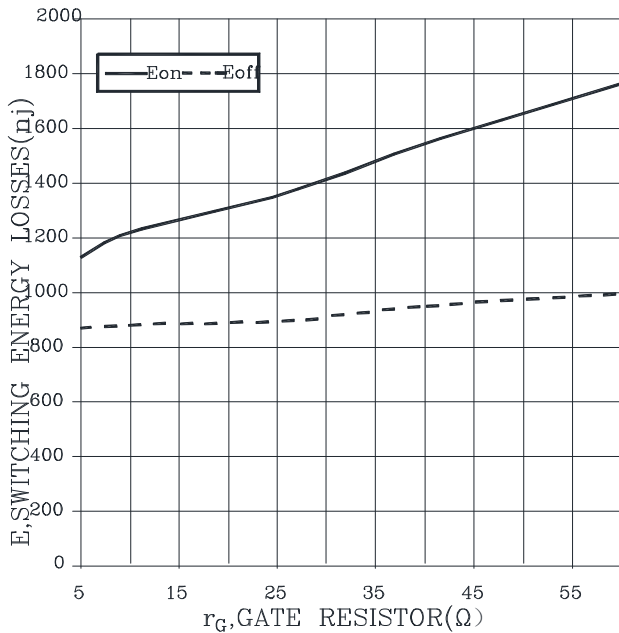
**Fig. 6 Typical  $V_{CE}$  VS.  $V_{GE}$  ( $T_J=25^\circ C$ )**



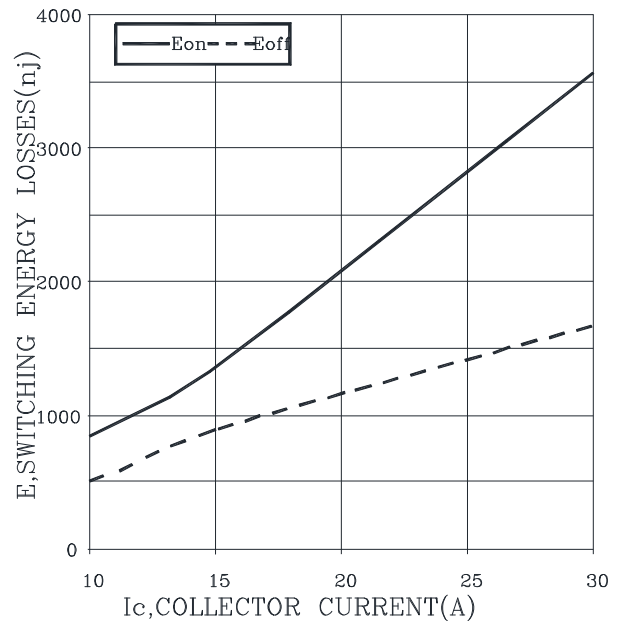
**Fig. 7 Typical switching times as a function of collector current (inductive load,  $T_C=25^\circ C$ ,  $L=500\mu H$ ,  $V_{CE}=600V$ ,  $V_{GE}=15V$ ,  $R_g=28\ \Omega$ )**



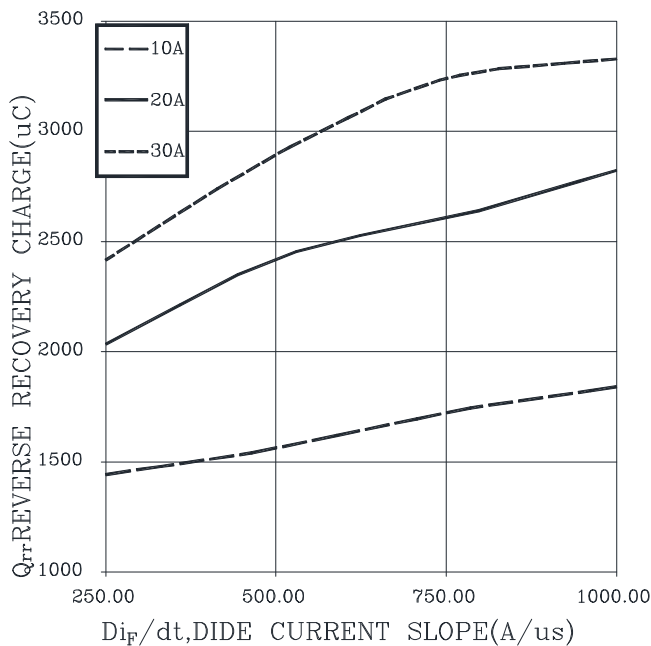
**Fig. 8 Typical switching times as a function of gate resistance (inductive load,  $T_C=25^\circ C$ ,  $L=500\mu H$ ,  $V_{CE}=600V$ ,  $V_{GE}=15V$ ,  $I_c=15A$ )**



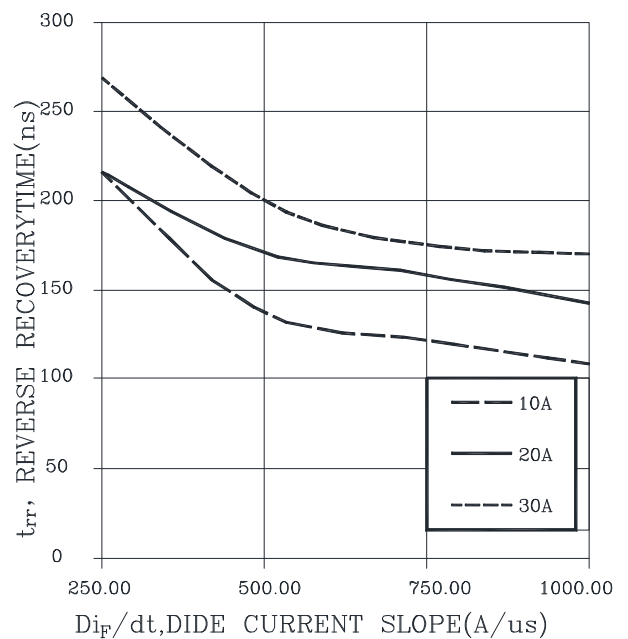
**Fig. 9 Typical energy loss VS.  $R_g$ , (inductive load,  $T_c=25^\circ\text{C}$ ,  $L=500\mu\text{H}$ ,  $V_{ce}=600\text{V}$ ,  $V_{ge}=15\text{V}$ ,  $I_c=15\text{A}$ )**



**Fig. 10 Typical switching energy losses as a function of collector current (inductive load,  $T_c=25^\circ\text{C}$ ,  $L=500\mu\text{H}$ ,  $V_{ce}=600\text{V}$ ,  $V_{ge}=15\text{V}$ ,  $R_g=28\ \Omega$ )**

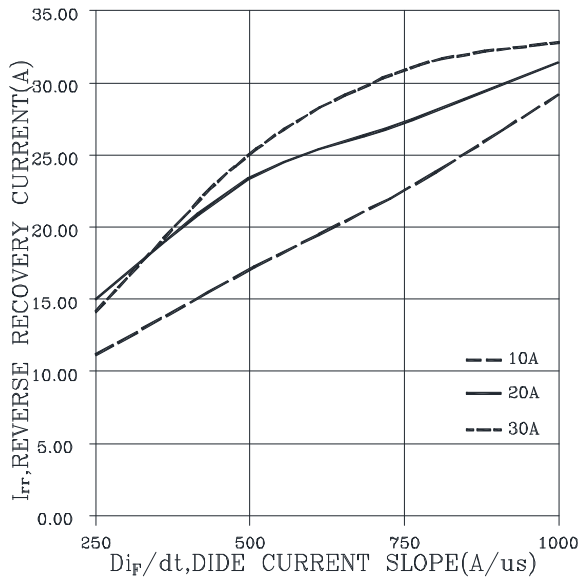


**Fig. 11 Typical Diode  $Q_{rr}$  VS.  $dI_F/dt$  ( $V_{cc}=600\text{V}$ ,  $V_{ge}=15\text{V}$ )**

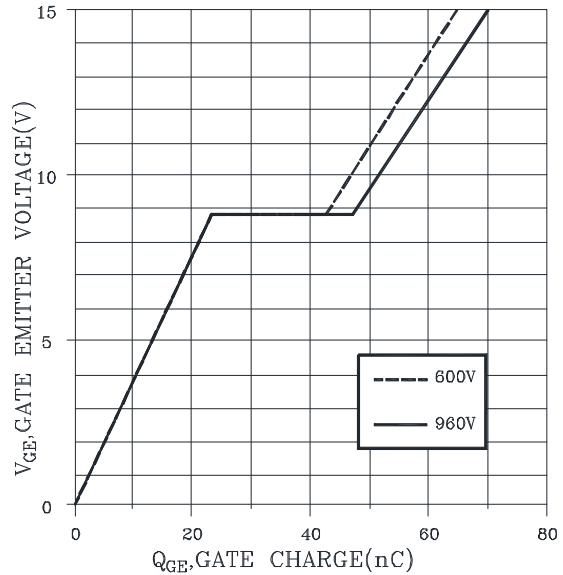


**Fig. 12 Typical reverse recovery time as a function of diode current slope ( $V_{cc}=600\text{V}$ ,  $V_{ge}=15\text{V}$ )**

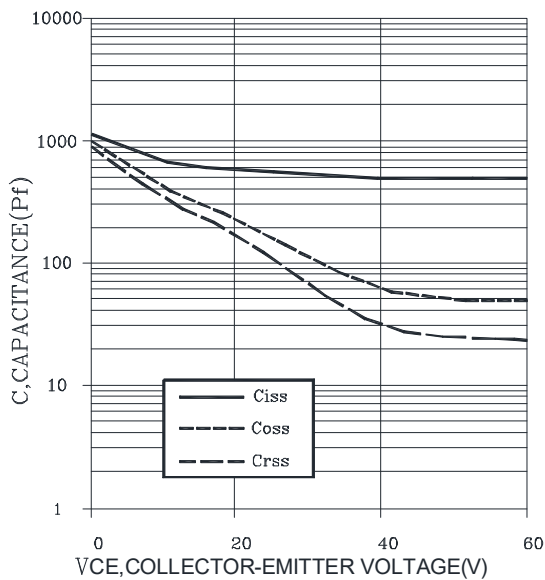




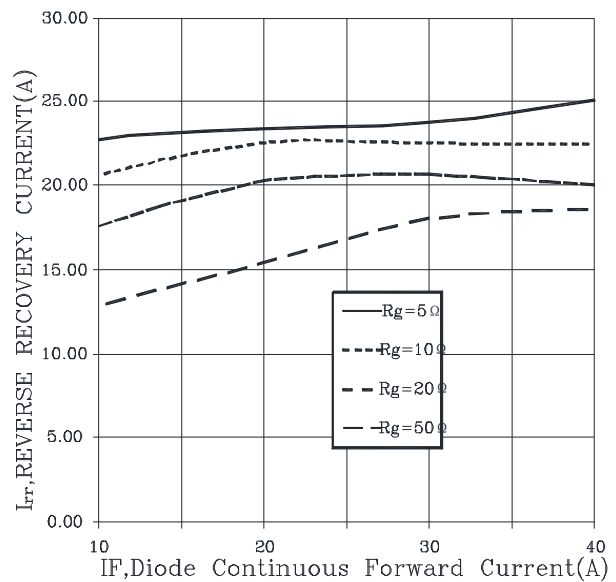
**Fig. 13 Typical Diode  $I_{rr}$  VS.  $dI_F/dt$**   
( $V_{CC}=600V, V_{GE}=15V$ )



**Fig. 14 Typical gate charge ( $I_c=15A$ )**



**Fig. 15 Typical capacitance as a function of collector-emitter voltage ( $V_{GE}=0V, f=1MHz$ )**



**Fig. 16 Typical Diode  $I_{rr}$  VS.  $I_F$ ,**  
( $T_c=25^\circ C, V_{CC}=600V, V_{GE}=15V$ )

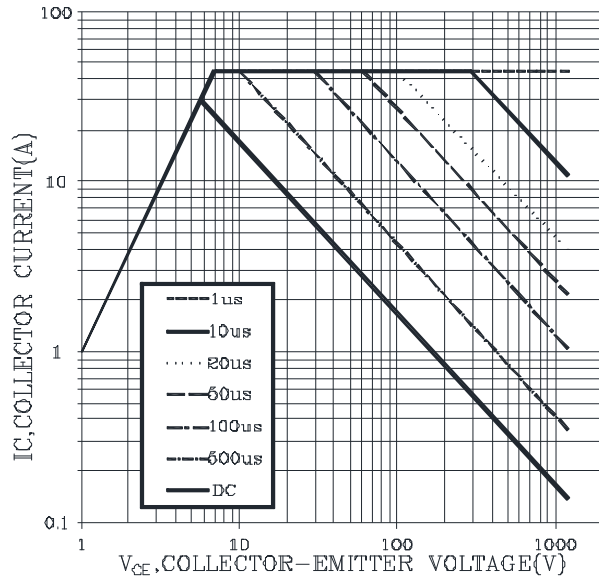


Fig. 17 Forward SOA,  $T_c=25^\circ\text{C}$ ,  $T_J \leq 150^\circ\text{C}$

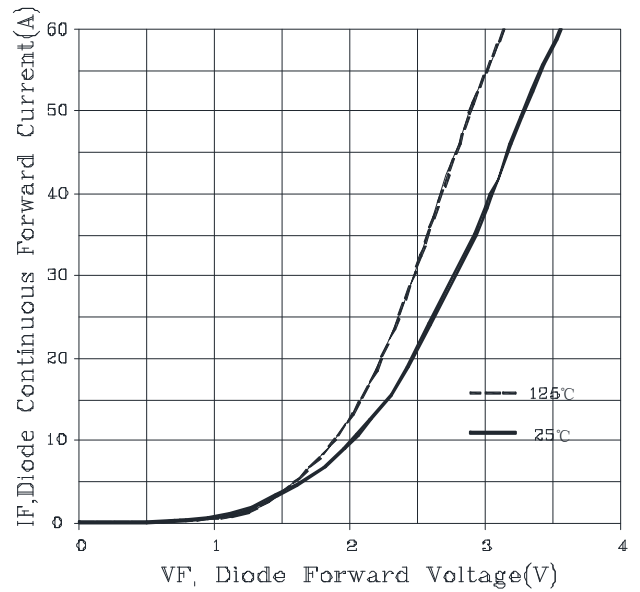


Fig. 18 Typical Diode Forward Characteristic,  $t_p=300\mu\text{s}$

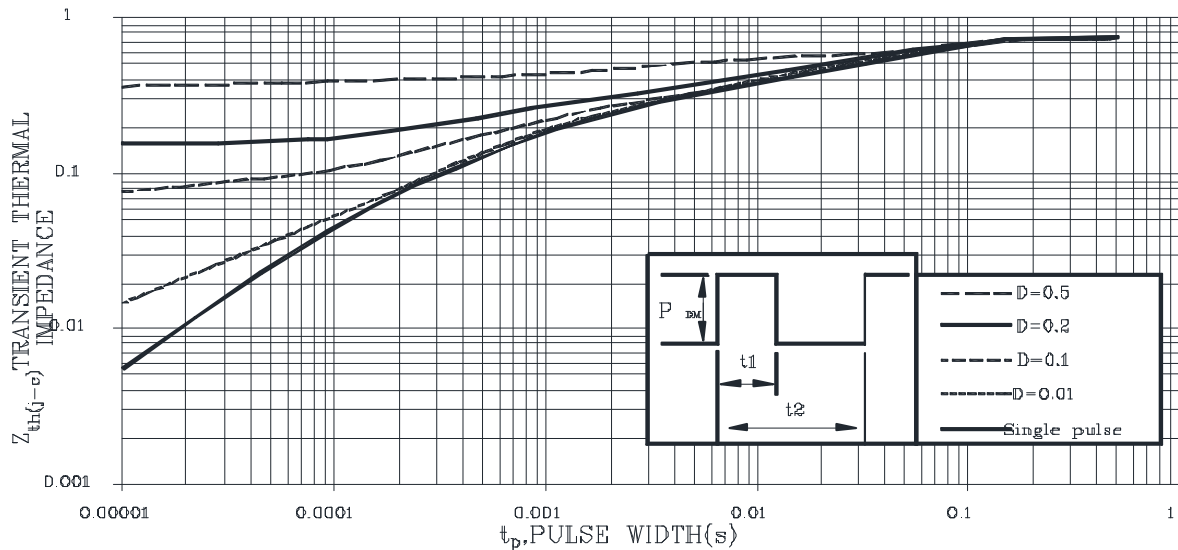


Fig. 19 Normalized Transient Thermal Impedance, Junction-To-Case

Note1: Duty factor  $D=t_1/t_2$ ; Note2: peak  $T_J=PDM \times Z_{thjc} + T_C$



# Trench Field-Stop Technology IGBT

PC15H120AB

REV:A / 0

## ● PART NO. SYSTEM :

P C 15 H 120 A C

